

ul. Harcerska 8, 18-100 Łapy, tel. 085 715 33 28, fax 085 715 76 81 PKO BP S.A. 96 1020 1332 0000 1502 0324 0447 NIP: 966-176-77-14, REGON: 200133730 www.termopasty.pl, e-mail: biuro@termopasty.pl

Product Data Sheet



Heat conductive copper paste

Copper-based thermal conducting paste. Is designet to fill joints between a processor and its radiator to improve cooling. Thermal conductivity $\sim 3.1 \text{ W/mK}$.

Package:

Capacity	Package	Symbol	
1,5 cm³	5	AGT-060	
40 g	2	AGT-061	

